

东莞市通科电子有限公司

DongGuan Tongke Electronic Co.,LTD

RS2AF THRU RS2MF

Surface Mount Fast Recovery Rectifiers Reverse Voltage - 50 to 1000 V

Forward Current - 2 A

FEATURES

- For surface mounted applications
- · Low profile package
- · Glass Passivated Chip Junction
- · Easy to pick and place
- Fast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

· Case: SMAF

• Terminals: Solderable per MIL-STD-750, Method 2026

Approx. Weight: 27mg / 0.00095oz

PINNING

PIN	DESCRIPTION				
1	Cathode				
2	Anode				



Top View

Marking Code: RS2A-RS2M Simplified outline SMAF and symbol

Absolute Maximum Ratings and Characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	RS2AF	RS2BF	RS2DF	RS2GF	RS2JF	RS2KF	RS2MF	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at T_c = 125 °C	I _{F(AV)}	2							А
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I _{FSM}	50							А
Maximum Forward Voltage at 2 A	V _F	1.3							V
Maximum DC Reverse Current T _a = 25 °C at Rated DC Blocking Voltage T _a = 125 °C	I _R	5 100						μА	
Typical Junction Capacitance at V _R =4V, f=1MHz	C _j	22						pF	
Maximum Reverse Recovery Time (1)	t _{rr}	150 250 500			00	ns			
Typical Thermal Resistance (2)	$R_{ heta_{JA}}$ $R_{ heta_{JC}}$	65 20						°C/W	
Operating and Storage Temperature Range	T_{j},T_{stg}	-55 ~ +150							°C

^(1) Measured with $I_{\scriptscriptstyle F}$ = 0.5 A, $I_{\scriptscriptstyle R}$ = 1 A, $I_{\scriptscriptstyle rr}$ = 0.25 A.

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⁽²⁾ P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.



Fig.1 Forward Current Derating Curve

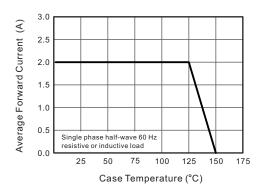


Fig.2 Typical Reverse Characteristics

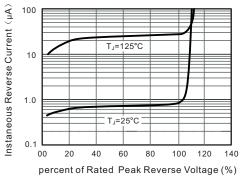


Fig.3 Typical Instaneous Forward Characteristics

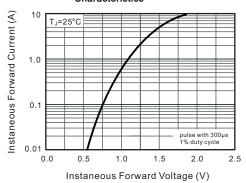


Fig.4 Typical Junction Capacitance

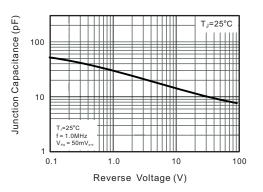
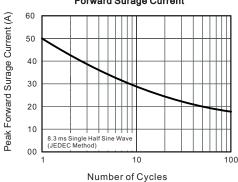


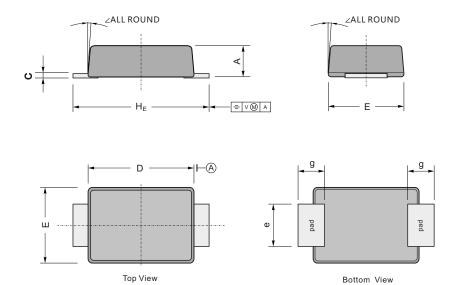
Fig.5 Maximum Non-Repetitive Peak Forward Surage Current





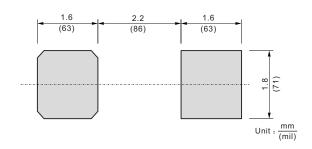
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads



UNIT		Α	С	D	Е	е	g	H _E	
mm	max	1.2	0.20	3.7	2.7	1.6	1.2	4.9	
	min	0.9	0.12	3.3	2.4	1.3	0.8	4.4	7°
mil	max	47	7.9	146	106	63	47	193	/
	min	35	4.7	130	94	51	31	173	

The recommended mounting pad size



Marking

Type number	Marking code				
RS2AF	RS2A				
RS2BF	RS2B				
RS2DF	RS2D				
RS2GF	RS2G				
RS2JF	RS2J				
RS2KF	RS2K				
RS2MF	RS2M				